

# MS-8854

NV20, 4MX16 DDR, RGB, EXTERNAL DVI-I, TV-DOWN, TV IF , AGP4X

NVVD SET TO: 1.67V  
FBVDD SET TO: 3.63V  
FBVDDQ SET TO: 2.59V

## HISTORY REVISION:

X00: Based on P50-A06  
- See change list in 149- file.  
- Set FBVDDQ=2.59V

### P50-A07-X01:

- Changed all memory clk/clk# diff pair resistors to 68R 5% (from 47R)

### P50-A08:

X04: - Delay PLL\_VDD to come up after NVDD.  
X05: - Added 1UF accross R257.  
X06: - Removed X04-5 above, added a switcher generated PLL delay option.  
- SSEN A cap for 2nd SW changed to 1UF.  
- A05 Si, NVVD=1.52V

### P50-A09:

X02: - Changed PLL VDD and DAC VDD to be gated by Fet controlled by FBVDD power good signal.  
X03: - Added option to pull up power good to 12V  
ECO1235: - Changed R841 PU to 10K (from 4.7K)

P50-A10: Removed unintended shorts between the analog ground and the digital ground (layout affected only).

P50-A11: Isolate analog and chassis GND from the main digital GND.

Generate clean 3.3V onboard (3.3VL), used on TV, TMDS and DAC/PLL.

Added 100R resistor on each of the lower FET in series with 680pf.

Removed Shunt Regulator TL431 used previously for external TMDS.

RGB filters are now back to P50-A09 style.

Removed SLI connector.

Added Linear bypass option resistor.

Reference PVCC1 and PVCC2 filtering caps to PGND pin (digital GND).

All plane bridge 'X' components will be initially stuffed with 0R resistors.

Power Supply power sequencing to remain as P50-A09 style.

X76 is where A11 and B00 are brahced off.

B00 is official after Dell's review.

B00-X01: R241 and R242 silkscreens are swapped. The bd may look like R241=NOSTUFF and R242=STUFF (but it's the other way around: BOM is correct).

### B00-X02:

Added diff pairs parallel terminations (Res, 0603, 300R)

Populated C897 with 150uF to lower DFP supply noise.

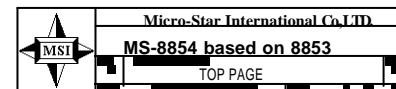
C00: Added 700mA circuit from 5V to 3.3V

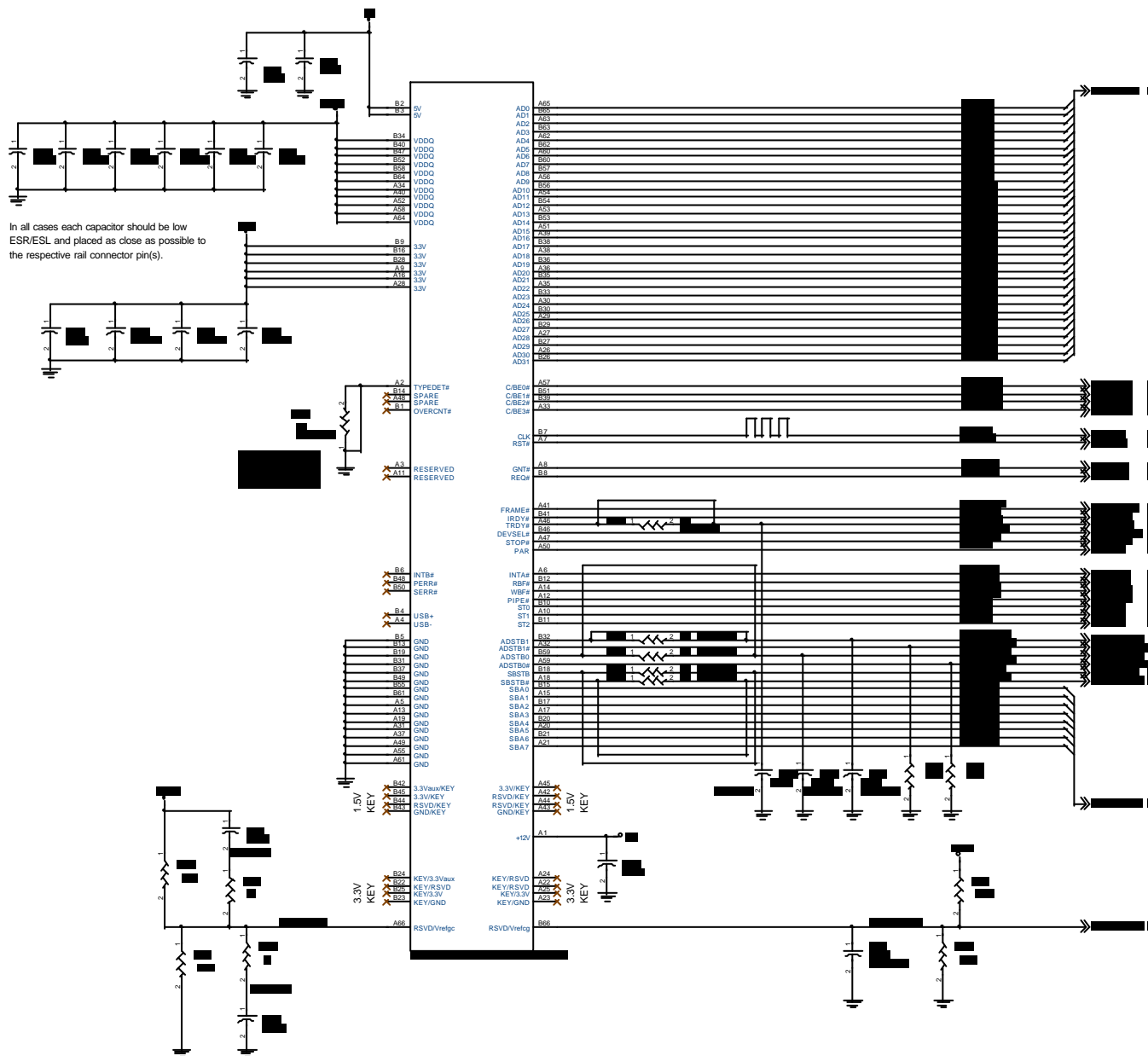
No Stuff on 3.3V Power Patch.

Set FBVDD to 3.6V max.

C01 : 1. Added L804 to connect PLL\_VDD\_SW to FBVDD  
2. Changed R259 and R261 connected to PLL\_VDD\_SW net created, was connected to 3.3VL  
3. Added two more ground termination 0-ohm resistors X13 and X14.

## 0. TOP PAGE





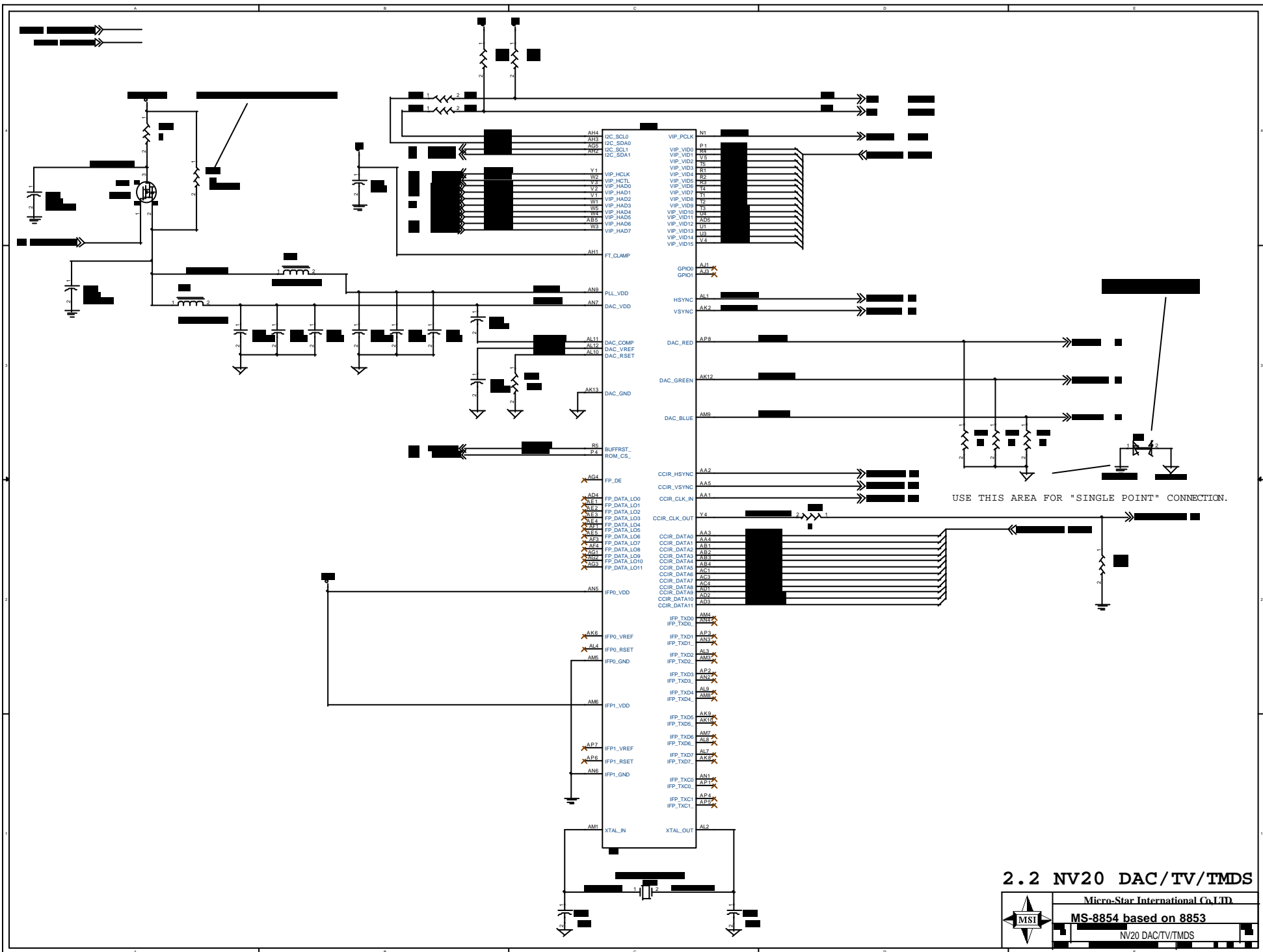


**Micro-Star International Co.LTD.**

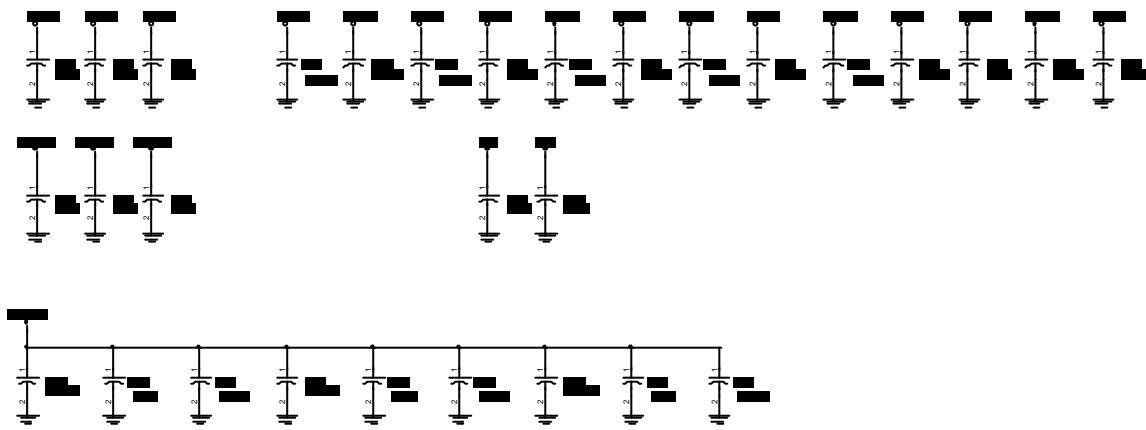
MS-8854 based on 8853

NV20 HOST






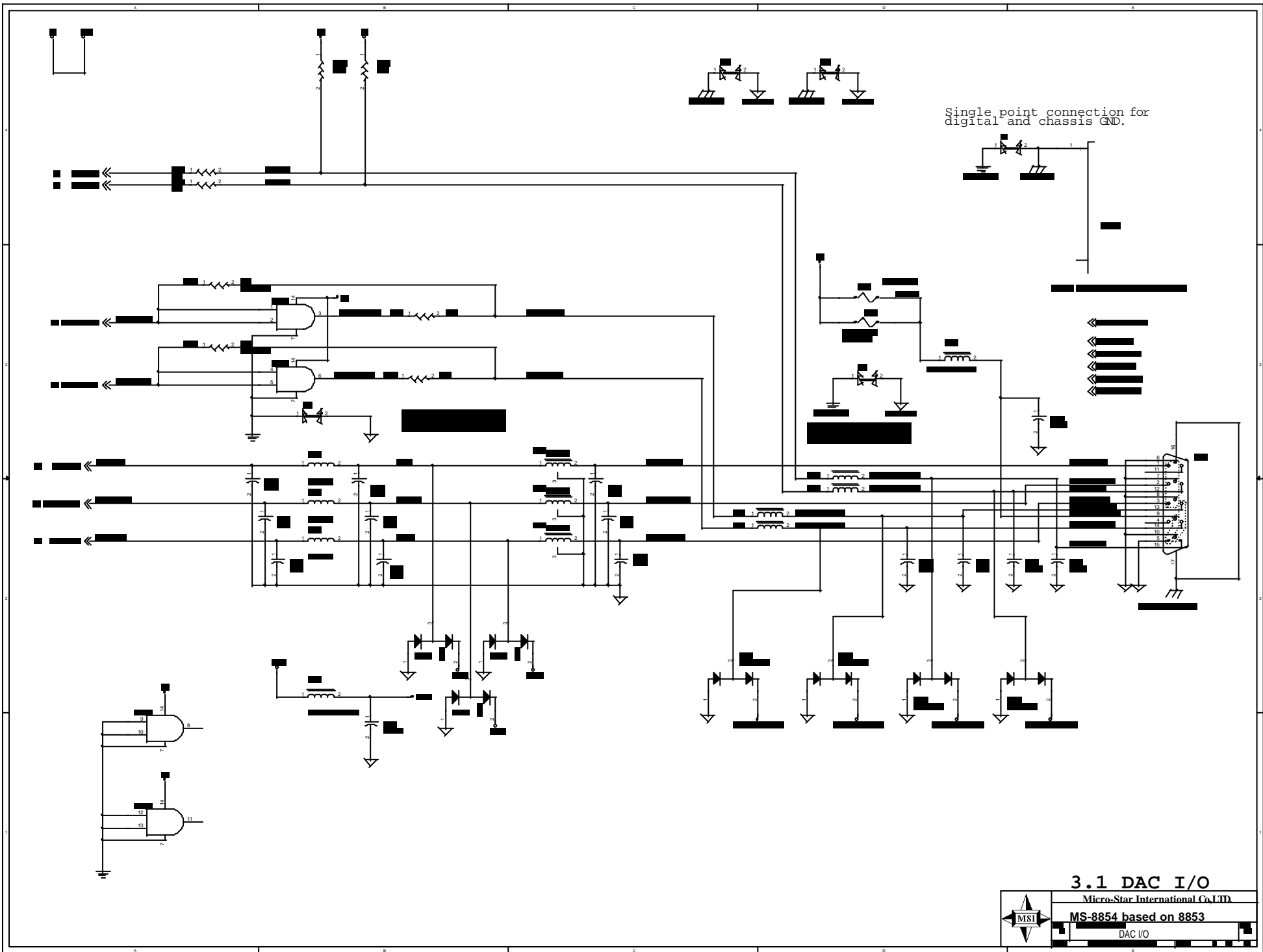
Use thick (non-impedance controlled) traces on XTALIN/OUT




## 2.3 NV20 DECOUPLING

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	MS-8854 based on 8853
	NV20 DECOUPLING





Single point connection for digital and chassis GND.

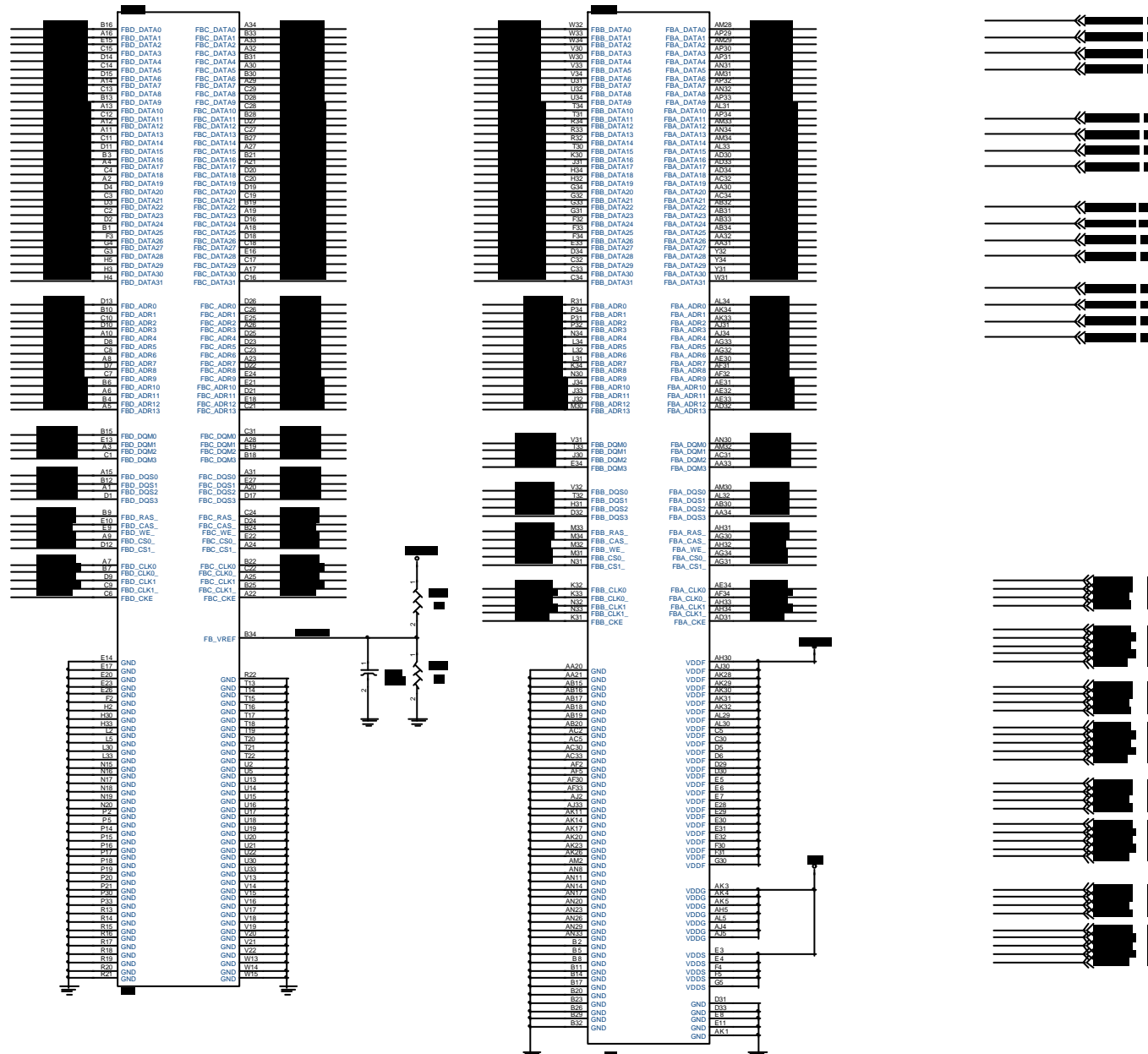


### 3.1 DAC I/O

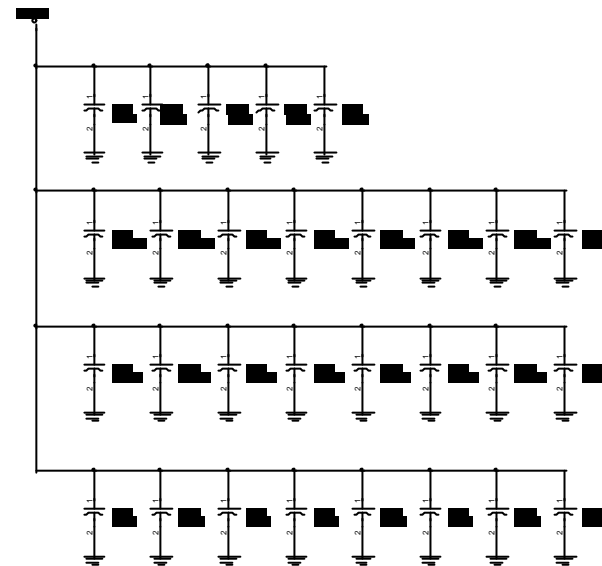
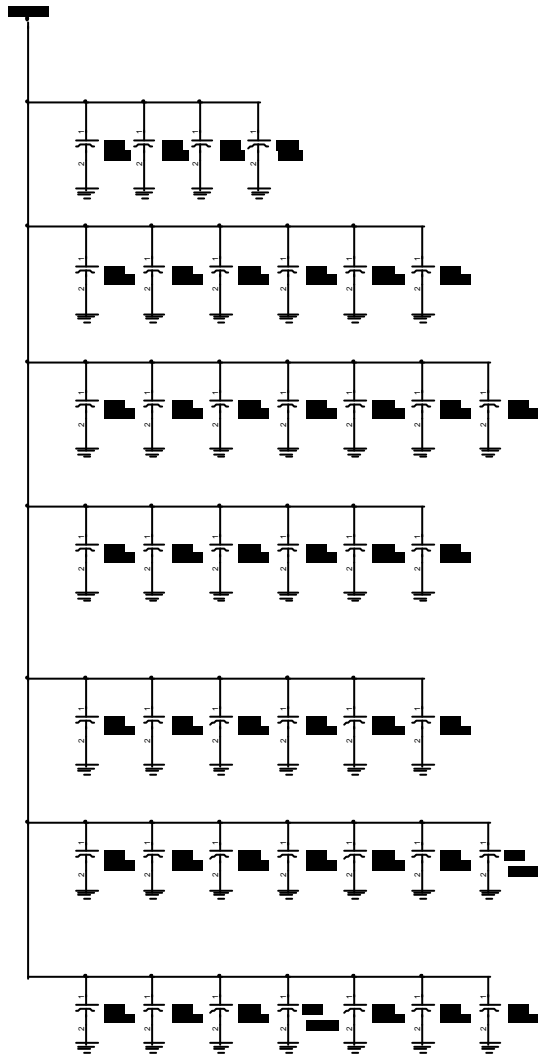
Micro-Star International Co., LTD.

**MS-8854 based on 8853**

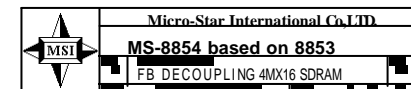
DAC I/O

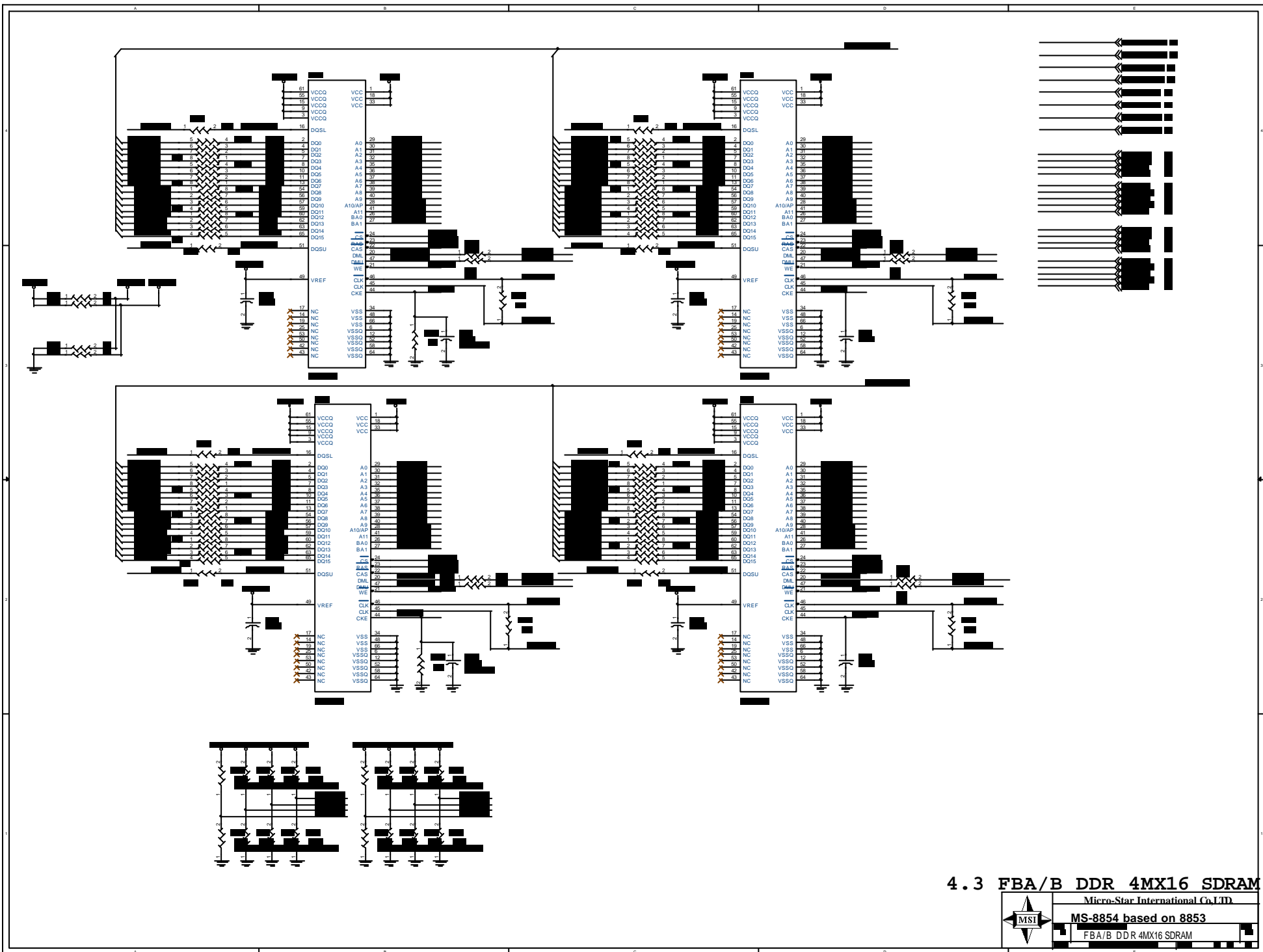




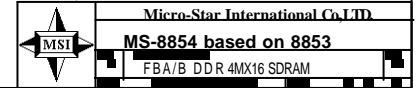


#### 4.2 FB DECOUPLING 4MX16 SDRAM





#### 4.3 FBA/B DDR 4MX16 SDRAM



FBC/D DDR 4MX16 SDRAM

